Specification of Thermoelectric Module

TEC1-24126

Description

The 241 couples, 55 mm × 55 mm size single module which is made of our high performance ingot to achieve superior cooling performance and 70 $^{\circ}$ C or larger delta T max, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

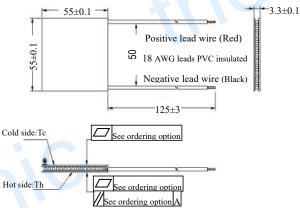
Performance Specification Sheet

Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Th(°C)	27	50	Hot side temperature at environment: dry air, N2
DTmax(°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side
	20.20	22 (0	
Umax(Voltage)	30.36	32.69	Voltage applied to the module at DTmax
Imax(amps)	25.7	25.7	DC current through the modules at DTmax
QCmax(Watts)	488.6	533.5	Cooling capacity at cold side of the module under DT=0 °C
AC resistance(ohms)	0.90	0.96	The module resistance is tested under AC
Tolerance (%)	±	- 10	For thermal and electricity parameters

Geometric Characteristics Dimensions in millimeters



Manufacturing Options

A. Solder:	B. Sealant:
1. T100: BiSn (Tmelt=138°C)	1. NS: No sealing (Standard)
2. T200: CuAgSn (Tmelt = 217°C)	2. SS: Silicone sealant
3. T240: SbSn (Tmelt = 240°C)	3. EPS: Epoxy sealant
C. Ceramics:	D. Ceramics Surface Options:
1. Alumina (Al ₂ O ₃ , white 96%)	1. Blank ceramics (not metalized)

2. Aluminum Nitride (AlN)

2. Metalized Naming for the Module

Ordering Option

Suffix	Thickness / H (mm)	Flatness/ Parallelism (mm)	Lead wire length(mm) Standard/Optional length	TEC1-24126- X -X - X - X T Ceramics Flatness/Paralleli
TF	0:3.3±0.1	0:0.1/0.1	125±3/Specify	Solder
TF	1:3.3±0.05	1:0.05/0.05	125±3/Specify	TEC1-24126-T100 -NS -TF00 -AIO T100 BiSn(Tmelt=138°C)
Eg. TF0	0: Thickness 3.	3±0.1(mm) and Flatne	ess 0.1/0.1(mm)	NS: No sealing AlO: Alumina (Al2O3, TE00: Thickness ±0.1(mm) and Elatness/Parallelism: 0.0

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10

5

0

0

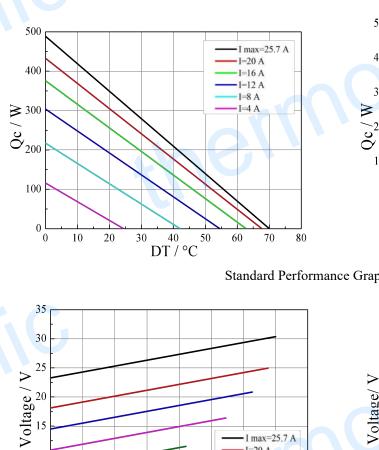
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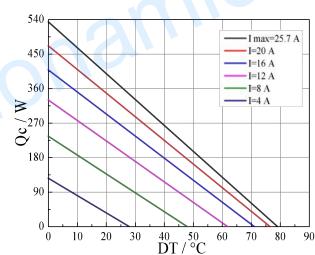
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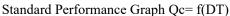


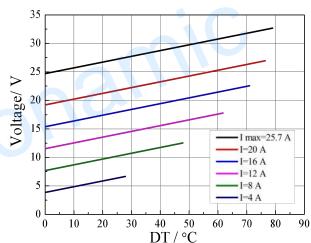
00 DT / °C 50

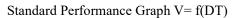
Performance Curves at Th=27 °C



Performance Curves at Th=50 °C







I max=25.7 A

70

80

I=20 A

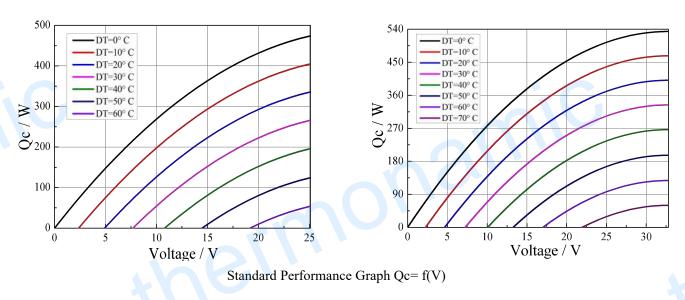
I=16 A

I=12 A

I=8A

I=4A

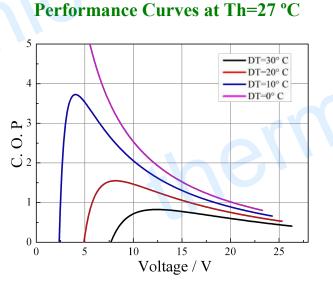
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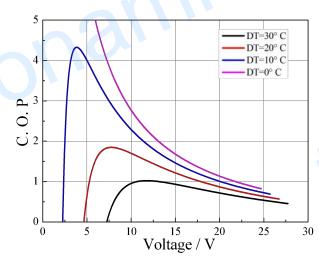


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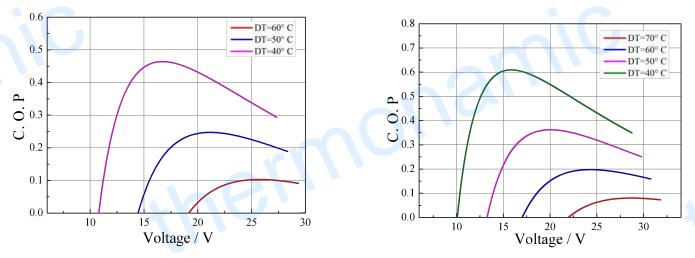
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Performance Curves at Th=50 °C

Standard Performance Graph COP = f(V) of ΔT ranged from 0 to 30 °C



Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power (V × I).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- Susur • Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC